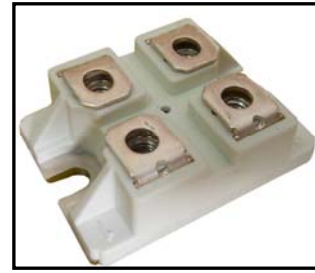


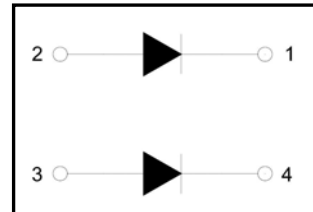
PRODUCT FEATURES

- Ultrafast Reverse Recovery Time
- Soft Reverse Recovery Characteristics
- Low Reverse Recovery Loss
- High System Power Density
- Popular SOT-227 Package



APPLICATIONS

- Inversion Welder
- Uninterruptible Power Supply (UPS)
- Plating Power Supply
- Ultrasonic Cleaner and Welder
- Converter & Chopper
- Power Factor Correction (PFC) Circuit



ABSOLUTE MAXIMUM RATINGS

 $T_C=25^{\circ}\text{C}$ unless otherwise specified

Symbol	Parameter	Test Conditions	Values	Unit
V_R	Maximum D.C. Reverse Voltage		1200	V
V_{RRM}	Maximum Repetitive Reverse Voltage		1200	V
$I_{F(AV)}$	Average Forward Current	$T_C=90^{\circ}\text{C}$, Per Diode	60	A
		$T_C=90^{\circ}\text{C}$, Per Moudle	120	A
		$T_C=90^{\circ}\text{C}$, 20KHz, Per Moudle	80	A
$I_{F(RMS)}$	RMS Forward Current	$T_C=90^{\circ}\text{C}$, Per Diode	84	A
I_{FSM}	Non-Repetitive Surge Forward Current	$T_J=45^{\circ}\text{C}$, $t=10\text{ms}$, 50Hz, Sine	500	A
		$T_J=45^{\circ}\text{C}$, $t=8.3\text{ms}$, 60Hz, Sine	550	A
I^2t	I^2t (For Fusing)	$T_J=45^{\circ}\text{C}$, $t=10\text{ms}$, 50Hz, Sine	1250	A^2s
		$T_J=45^{\circ}\text{C}$, $t=8.3\text{ms}$, 60Hz, Sine	1512	A^2s
P_D	Power Dissipation		208	W
T_J	Junction Temperature		-40 to +150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range		-40 to +125	$^{\circ}\text{C}$
V_{isol}	Insulation Test Voltage	AC, $t=1\text{min}$	3000	V
Torque	To-Sink	Recommended (M4)	0.7~1.1	N·m
Torque	To-Terminal	Recommended (M4)	0.7~1.1	N·m
$R_{\theta JC}$	Thermal Resistance	Junction-to-Case	0.6	$^{\circ}\text{C}/\text{W}$
Weight			26.5	g

ELECTRICAL CHARACTERISTICS

$T_C=25^{\circ}\text{C}$ unless otherwise specified

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{RM}	Reverse Leakage Current	$V_R=1200\text{V}$	--	--	0.5	mA
		$V_R=1200\text{V}, T_J=125^{\circ}\text{C}$	--	--	5	mA
V_F	Forward Voltage	$I_F=60\text{A}$	--	2.10	--	V
		$I_F=60\text{A}, T_J=125^{\circ}\text{C}$	--	1.75	--	V
t_{rr}	Reverse Recovery Time	$I_F=1\text{A}, V_R=30\text{V}, di_F/dt=-200\text{A}/\mu\text{s}$	--	40	--	ns
t_{rr}	Reverse Recovery Time	$V_R=600\text{V}, I_F=60\text{A}$ $di_F/dt=-200\text{A}/\mu\text{s}, T_J=25^{\circ}\text{C}$	--	90	--	ns
I_{RRM}	Max. Reverse Recovery Current		--	7.5	--	A
t_{rr}	Reverse Recovery Time	$V_R=600\text{V}, I_F=60\text{A}$ $di_F/dt=-200\text{A}/\mu\text{s}, T_J=125^{\circ}\text{C}$	--	320	--	ns
I_{RRM}	Max. Reverse Recovery Current		--	14	--	A

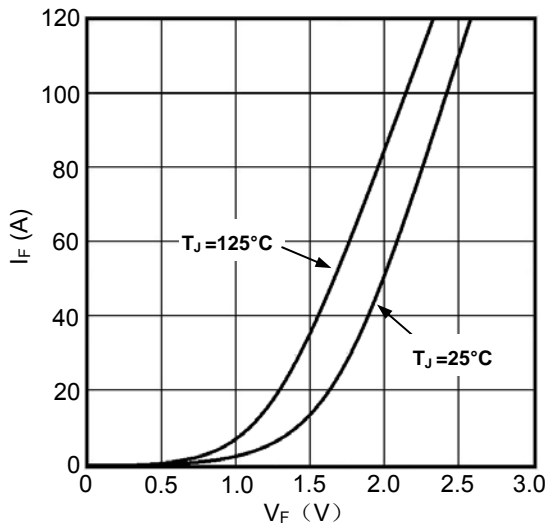


Figure1. Forward Voltage Drop vs Forward Current

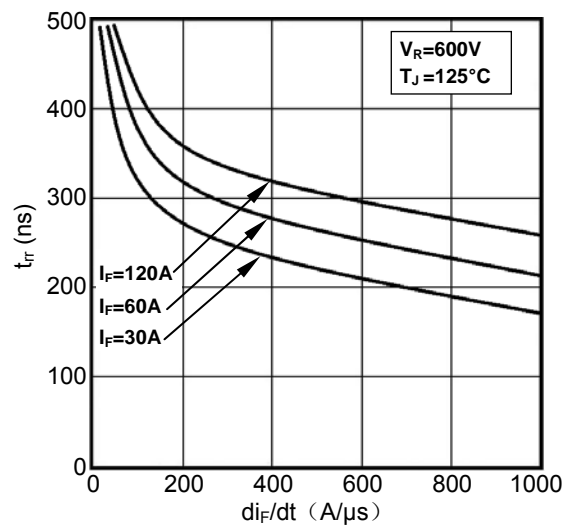


Figure2. Reverse Recovery Time vs di_F/dt

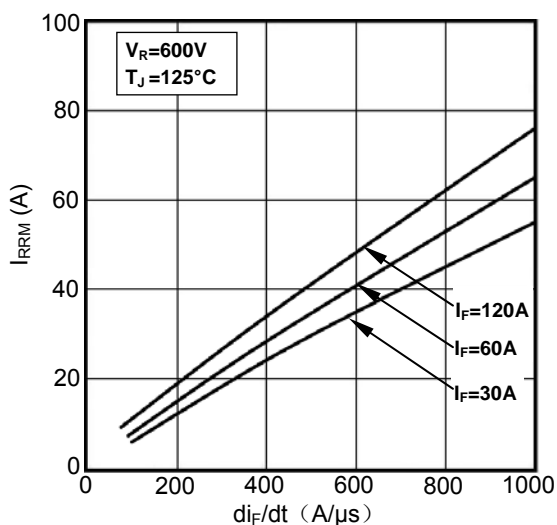


Figure3. Reverse Recovery Current vs di_F/dt

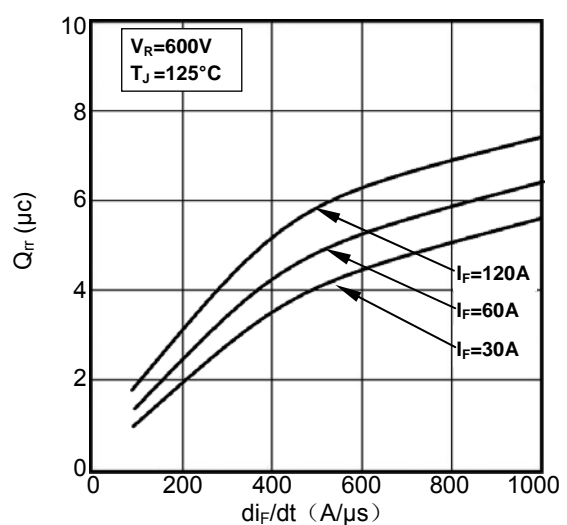


Figure4. Reverse Recovery Charge vs di_F/dt

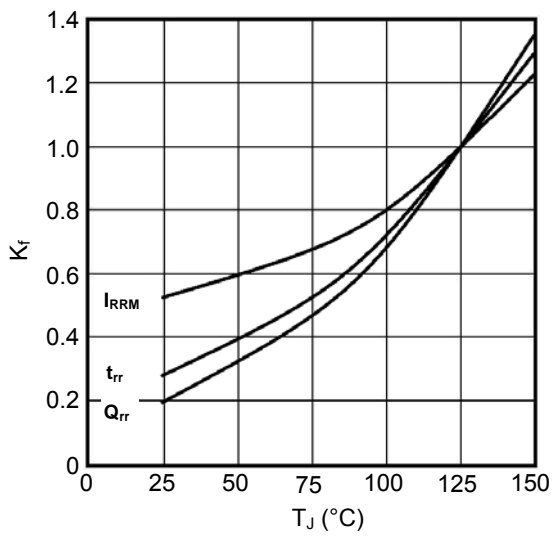


Figure5. Dynamic Parameters vs Junction Temperature

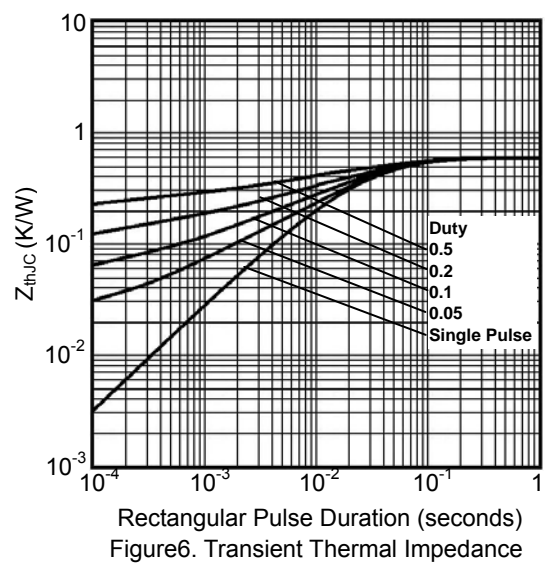
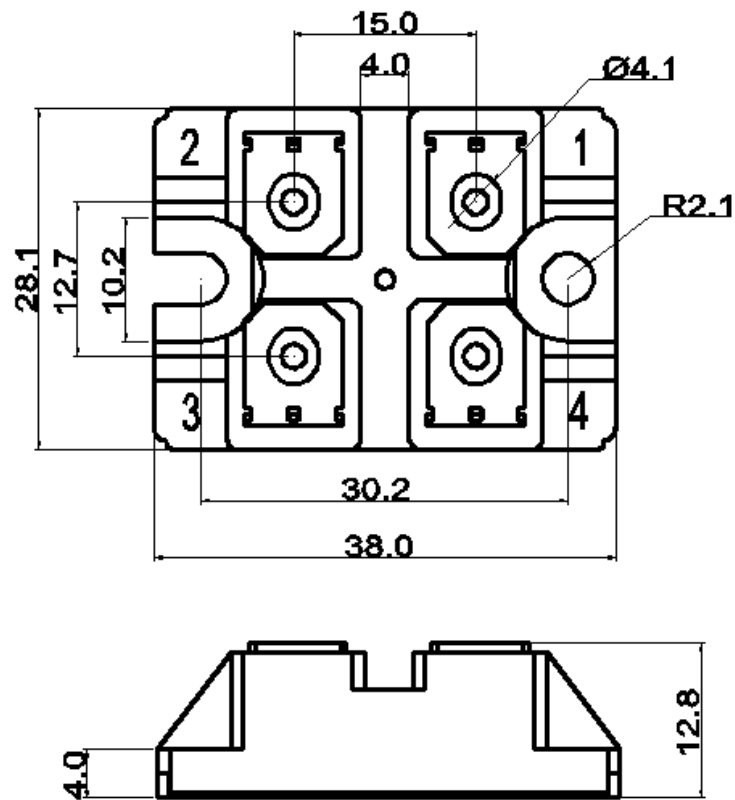


Figure6. Transient Thermal Impedance



Dimensions (mm)
Figure7. Package Outline